

Telink Semiconductor (Shanghai) Co., Ltd.

(date)2023/12/25

Federal Communications Commission
Authorization and Evaluation Division
7435 Oakland Mills Road
Columbia, MD 21046
USA

RE: Attestation Statements Part 2.911(d)(5)(i) request for
(FCCID:OEOTLSR9518APDG80)

[Telink Semiconductor (Shanghai) Co., Ltd.] (“the applicant”) certifies that the equipment for which authorization is sought is not “covered” equipment prohibited from receiving an equipment authorization pursuant to section 2.903 of the FCC rules.

Sincerely,

A handwritten signature in black ink that reads "Xiang Li". The signature is written in a cursive, slightly slanted style.

(Applicant signature)

(Applicant printed name):Xiang Li

Telink Semiconductor (Shanghai) Co., Ltd.

(date)2023/12/25

Eurofins Electrical and Electronic Testing NA, Inc.
914 West Patapsco Avenue
Baltimore, MD 21230

RE: Attestation Statements Part 2.911(d)(5)(ii) request for
(FCCID:OEOTLSR9518APDG80)

[Telink Semiconductor (Shanghai) Co., Ltd.] (“the applicant”) certifies that, as of the date of the filing of the application, the applicant is not identified on the Covered List as an entity producing “covered” equipment.

Sincerely,



(Applicant signature)

(Applicant printed name):Xiang Li